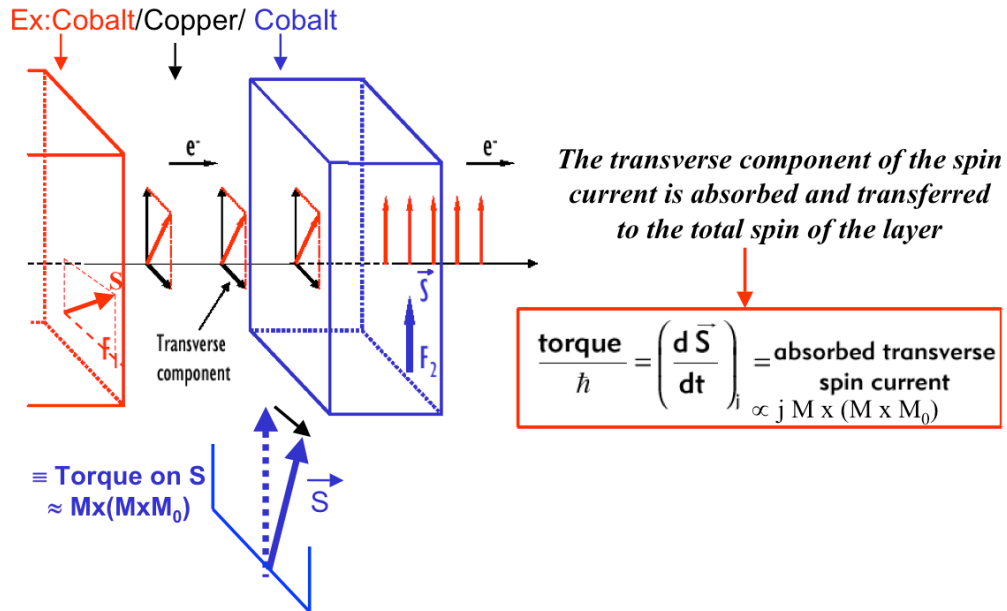
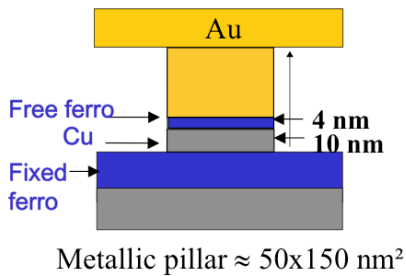


# Spin transfer

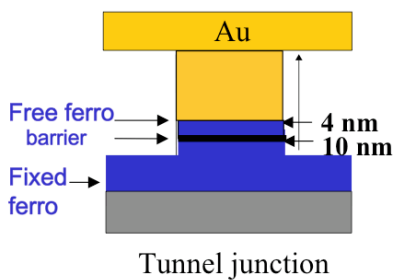
(J. Slonczewski, JMMM 1996, L. Berger, PR B 1996)



## Experiments on pillars



a) First regime (low H):  
 irreversible switching  
 (CIMS)



b) Second regime (high H):  
 steady precession  
 (microwave generation)

*E-beam lithography + etching*

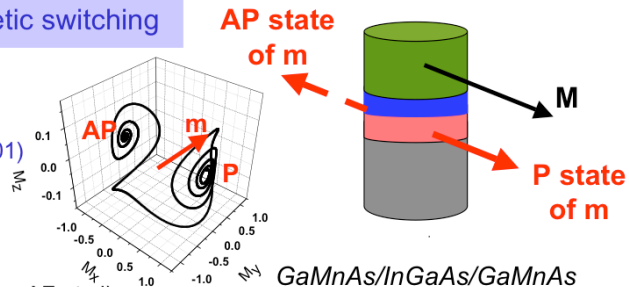
Regime of irreversible magnetic switching

First experiments on pillars:

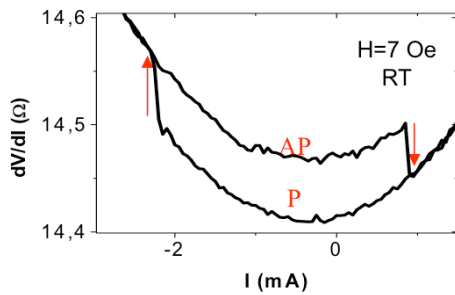
Cornell (Katine et al, PRL 2000)

CNRS/Thales (Grollier et al, APL 2001)

IBM (Sun et al, APL 2002)

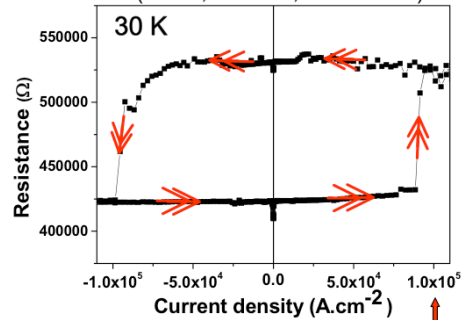


Py/Cu/Py 50nmX150nm (Boulle, AF et al)



GaMnAs/InGaAs/GaMnAs tunnel junction (MR=150%)

(Elsen, AF et al, PR B 2006)



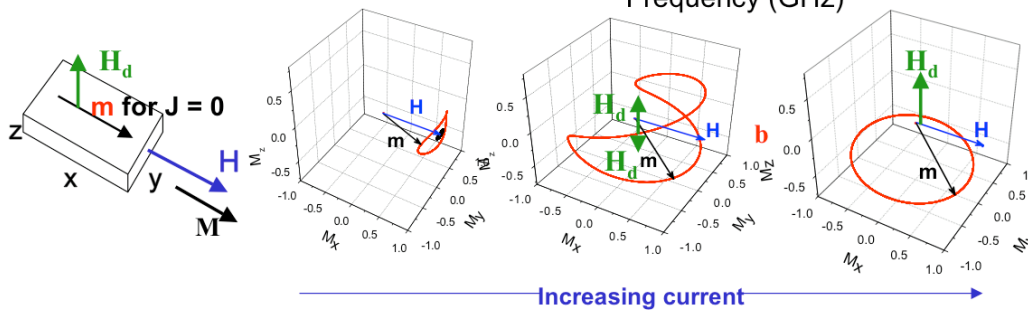
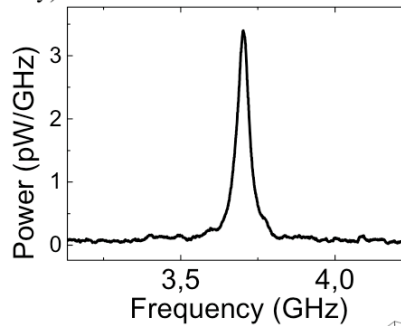
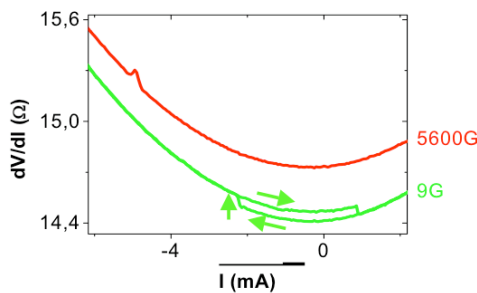
typical switching current  $\approx 10^7 \text{ A/cm}^2$   
 switching time can be as short as 0.1 ns (Chappert et al)

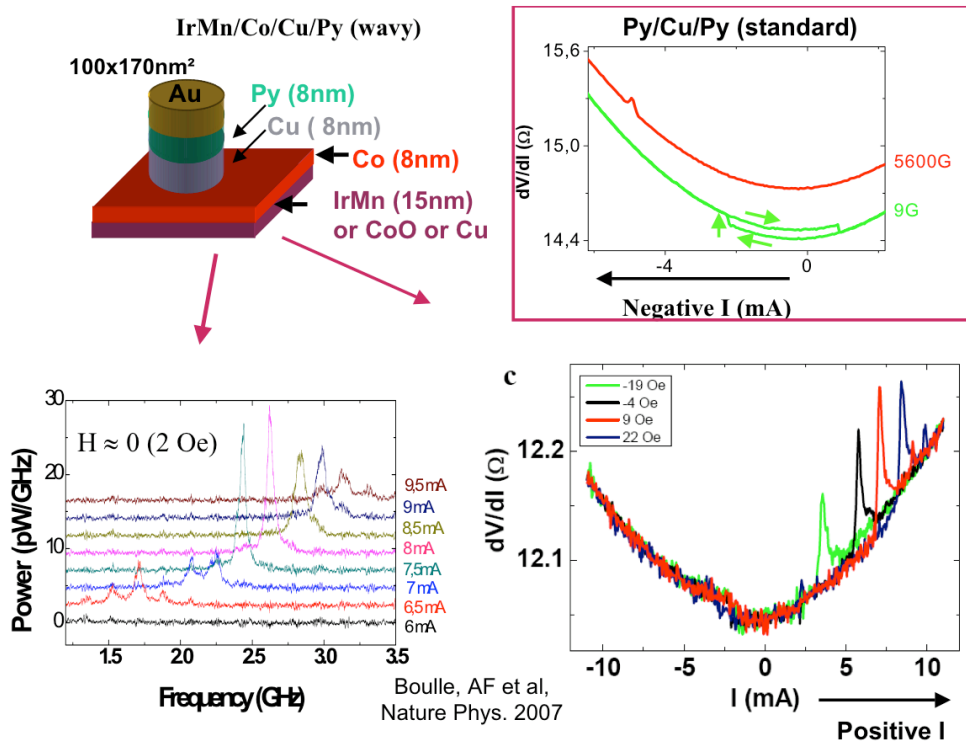
$1 \times 10^5 \text{ A/cm}^2$

Regime of steady precession (microwave frequency range)

CNRS/Thales, Py/Cu/PY (Grollier et al)

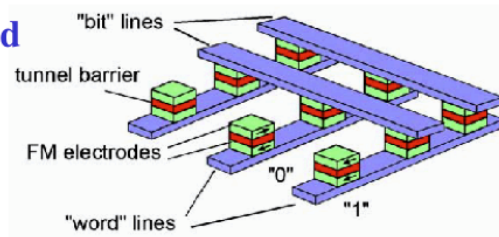
(Py = permalloy)





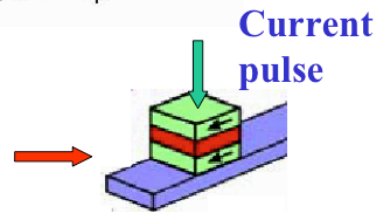
### Switching of reprogrammable devices (example: MRAM)

1) By external magnetic field  
*(present generation of MRAM, nonlocal, risk of « cross-talk » limits integration)*



2) «Electronic» reversal by spin transfer from current

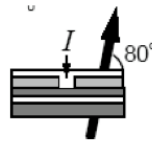
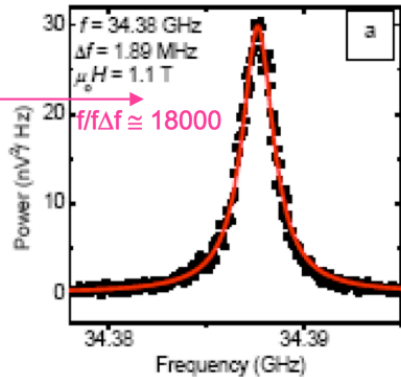
*(for the next generation of MRAM, with already promising demonstrations by several companies)*



## Spin Transfer Oscillators (STO) (communications, microwave pilot)

### Advantages:

- direct oscillation in the microwave range
- agility: control of frequency by only dc current, frequency modulation, fast switching (5-40 GHz)
- high quality factor
- small size ( $\approx 0.1\mu\text{m}$ ) and integration on chip (chip to chip communication)
- oscillations without applied field
- Needed improvements
- - increase of power by synchronization of a large of number of STO

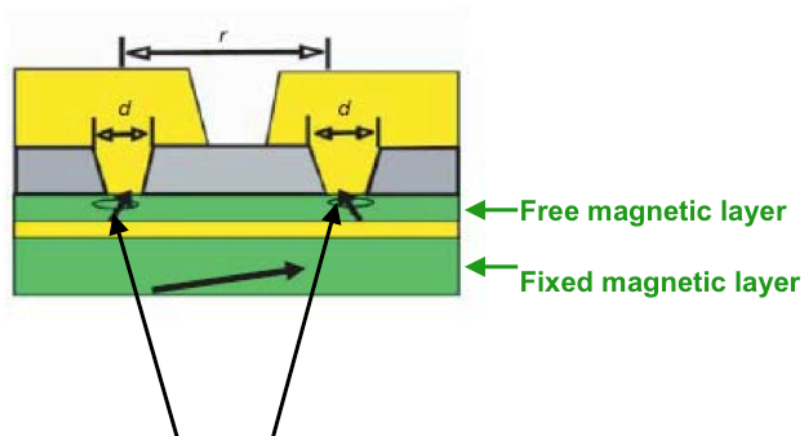


Rippart et al,  
PR B70, 100406,  
2004

## Synchronization of STOs

Synchronization by **exchange coupling** (magnetic elasticity)

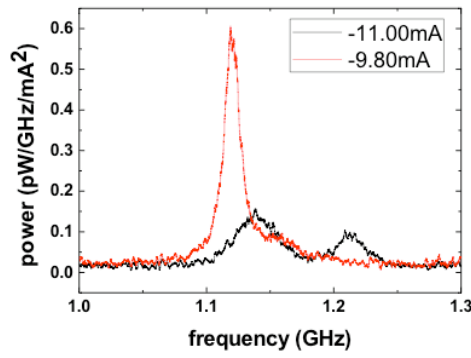
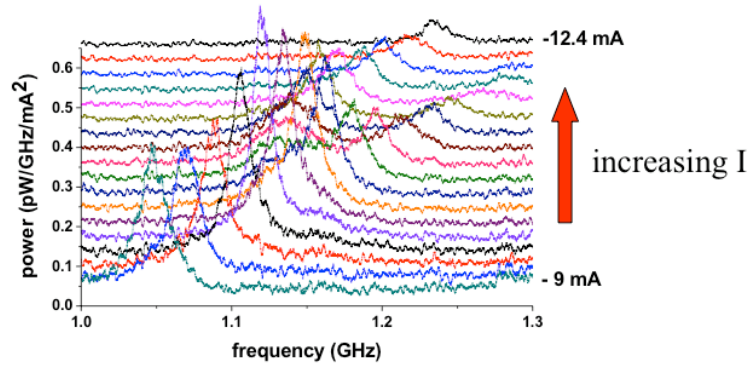
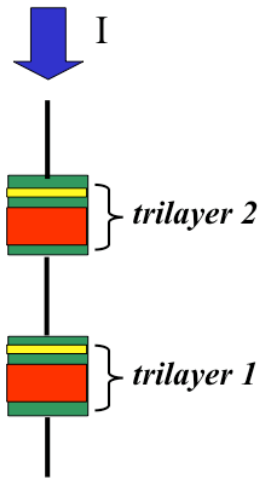
- Kaka et al (NIST Boulder) Nature 2005  
(similar results by Freescale)



Phase locking of oscillations for  $r \approx 500 \text{ nm}$

## Self-synchronization experiments (preliminary results)

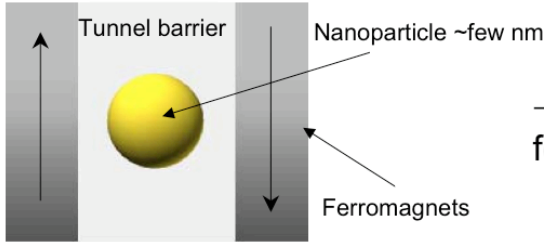
(B.Georges, AF et al, CNRS/Thales and LPN-CNRS)



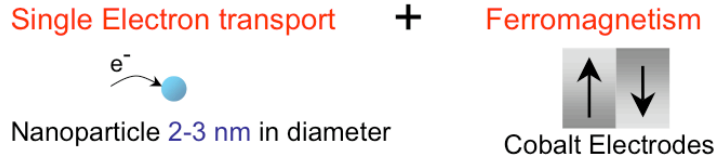
# Spintronics with single electron devices

## Nanospintronics

→ Connecting isolated nano-objects to ferromagnetic electrodes



→ A lot of theoretical works but very few experimental realizations...



→ Measure of **Magnéto-Coulomb** effects through a **single nanoparticle**

## Introduction to Coulomb blockade

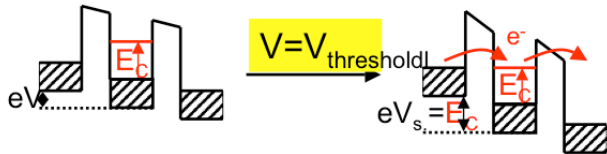
① It is not a quantum mechanics effects, just electrostatics!

② Translates the energy required to overcome the Coulomb repulsion in a reduced dimension system

→  $E_c = \frac{e^2}{2C}$  *Isolated sphere:*

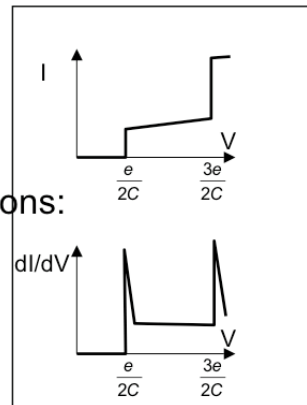
③ if d small enough then  $E_c \gg kT$

④ No current if  $V < V_T = \frac{e}{2C}$



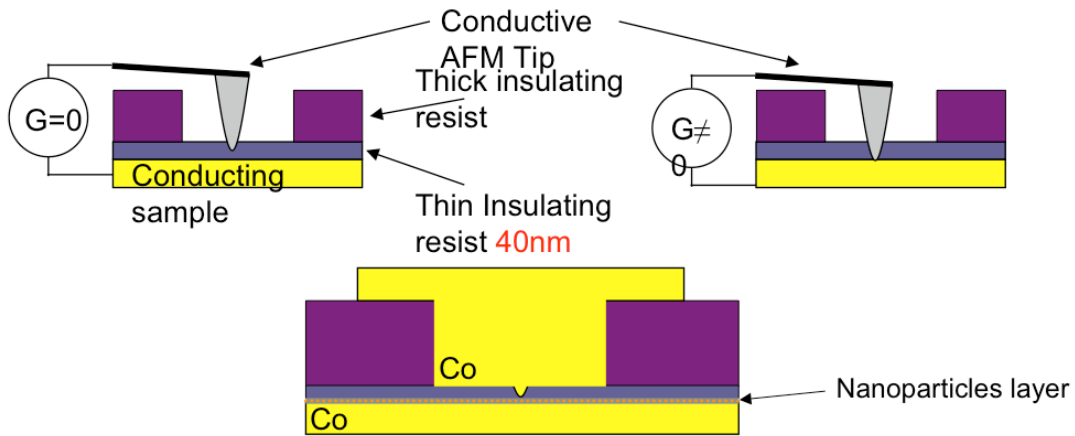
J. B. Barner et S. Ruggiero, PRL 59 (1987), p.109

**Observations:**



**Our solution to obtain a contact on a single nanoparticle**

Conductive tip AFM (CT-AFM) Nanoindentation: **real time** resistance monitoring



K. Bouzehouane et al., Nano Lett. 3, 1599 (2003)

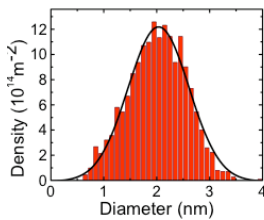
« AFM indenter makes holes for nanocontacts » <http://nanotechweb.org/articles/news/2/10/14/1>

**Nanostructure elaboration**

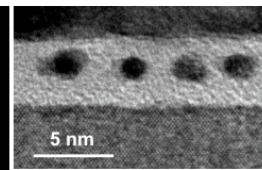
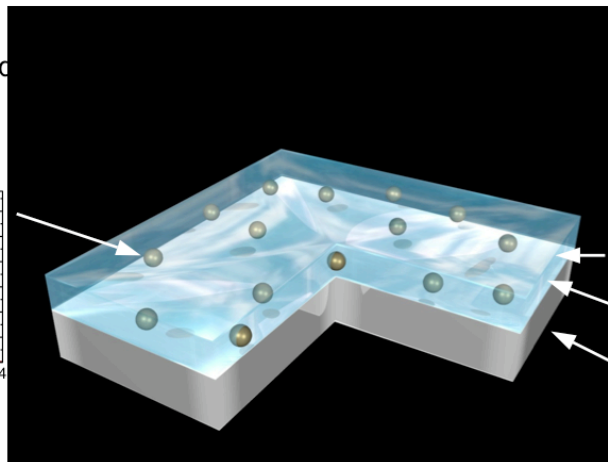
① Sputtering elaboration without top electrode

« Au self-assembled nanoparticles »

Au nominal ~0.2nm



Cluster diam. ~2nm

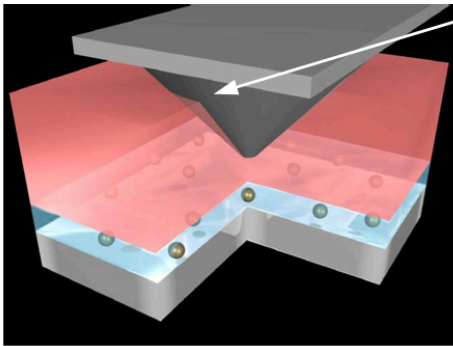


TEM cross section

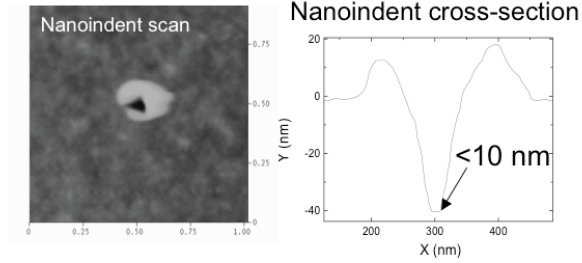
Al<sub>2</sub>O<sub>3</sub> ~1nm  
Al<sub>2</sub>O<sub>3</sub> ~1nm  
Cobalt

## Nanostructure elaboration

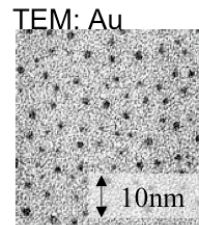
### ② Nanoindentation: Conductive Tip-AFM indentation



Conductive AFM tip

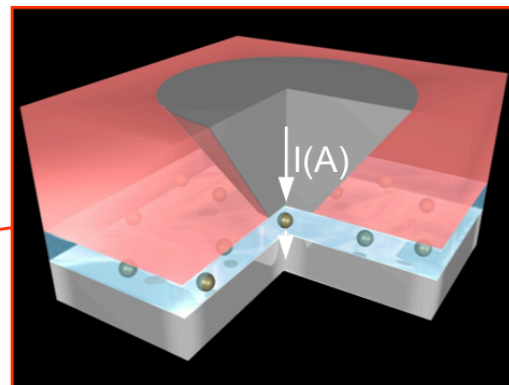
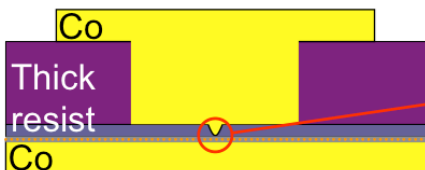


Contact surface smaller than  
 $10\text{nm} \times 10\text{nm}$   
 =  
 Ability to connect a single cluster



## MEASUREMENTS!

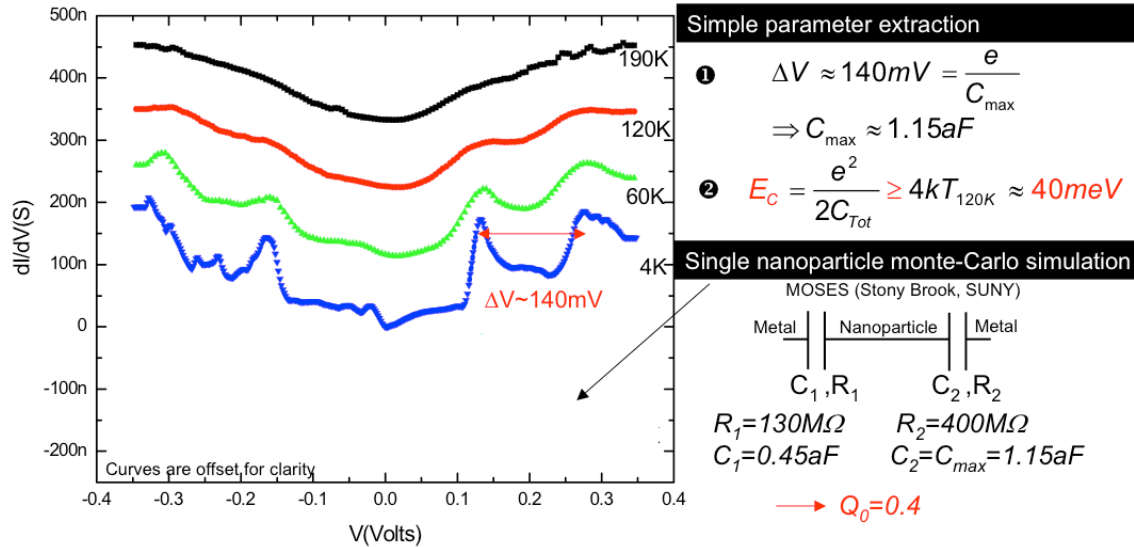
Co 15nm/ $\text{Al}_2\text{O}_3$  ~1nm/Au cluster  $\Phi_{\text{mean}}$  2~3nm/ $\text{Al}_2\text{O}_3$  ~1nm/Co 50nm





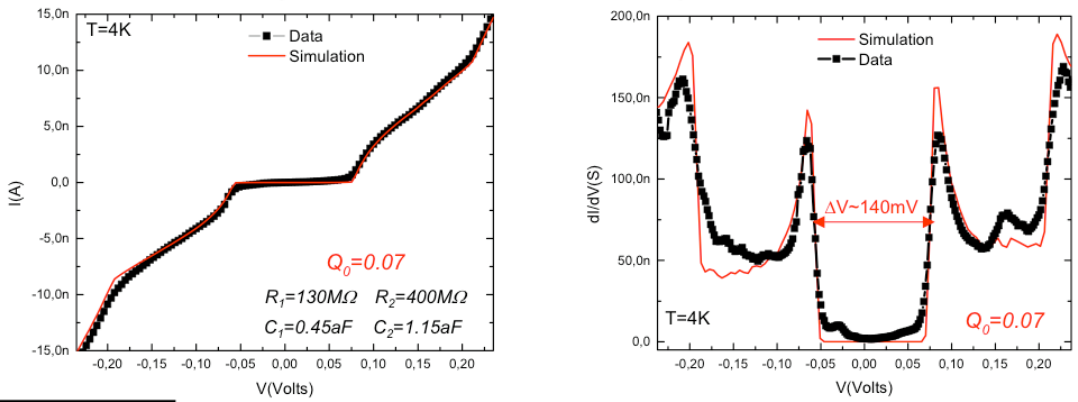
**Coulomb steps: decreasing temperature**

Co/Al<sub>2</sub>O<sub>3</sub>/Au cluster 2~3nm/Al<sub>2</sub>O<sub>3</sub>/Co



**Coulomb steps at 4K after high voltage cycling (change in Q0)**

Co/Al<sub>2</sub>O<sub>3</sub>/Au cluster 2~3nm/Al<sub>2</sub>O<sub>3</sub>/Co: same sample



**Charging energy:**

$$E_C = \frac{e^2}{2(C_1 + C_2)} \approx 50meV$$

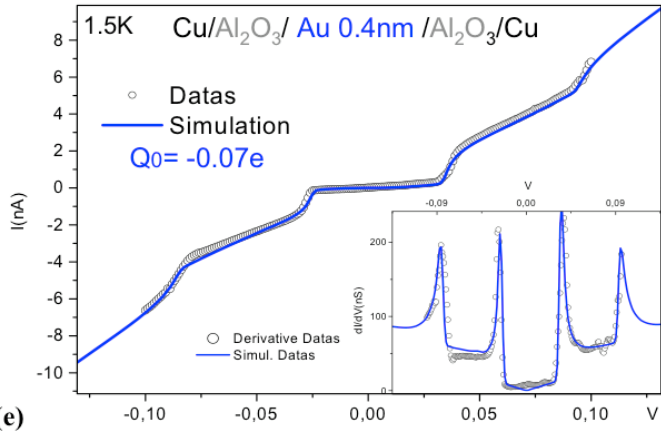
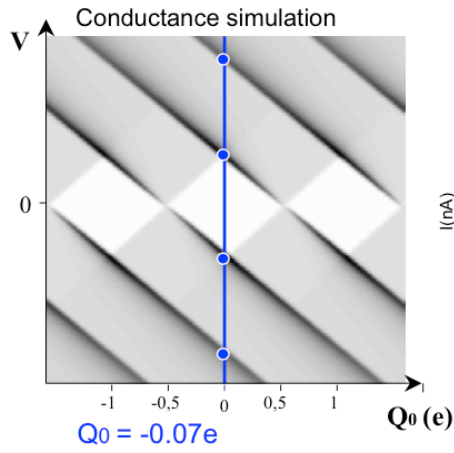
**Cluster size?**

Isolated sphere:  $d \approx \frac{C_{Tot}}{2\pi\epsilon} \approx 3.3nm$

More realistic (sphere+environment):  $d \approx 2.5nm$

The same parameters fits the two sets of curves → we connect a single cluster

Background charge effect



Tunnel junction parameters :



$C_1 = 2.5aF$   $C_2 = 2.7aF$   
 $R_1 = 1M\Omega$   $R_2 = 16M\Omega$

But this is not the most common situation !

Background charge effect

